

N-Channel Super Trench Power MOSFET

Description

The RM130N100T2 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

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Schematic diagram

General Features

- $V_{DS} = 100V, I_D = 130A$ $R_{DS(ON)} < 5.4 \text{m}\Omega @ V_{GS} = 10V$
- Excellent gate charge x R_{DS(on)} product
- Very low on-resistance R_{DS(on)}
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification
- Halogen-free

100% UIS TESTED! 100% ∆Vds TESTED!



TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
130N100	RM130N100T2	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

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Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (T _a =25℃)	I _D	130	Α
Continuous Drain Current (T _a =100℃)	I _D	84	Α
Pulsed Drain Current (1)	I _{DM}	440	Α
Single Pulsed Avalanche Energy (2)	E _{AS}	225	mJ
Power Dissipation	P _D	192	W
Thermal Resistance from Junction to Case	R _{θJC}	0.65	°C/W
Junction Temperature	TJ	150	$^{\circ}$
Storage Temperature	T _{STG}	-55~ +150	$^{\circ}$

Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Туре	Max	Unit
Static Characteristics	•		•			
Drain-source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	100	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =100V, V _{GS} = 0V	-	-	1	μΑ
Gate-body leakage current	I _{GSS}	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	-	-	±100	nA
Gate threshold voltage ⁽³⁾	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2	3	4	V
Drain-source on-resistance ⁽³⁾	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	4.5	5.4	mΩ
Gate Resistance	R _G	f=1MHz	-	3.5	-	Ω
Dynamic characteristics	·					
Input Capacitance	C _{iss}		-	3244	-	pF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V, f =1MHz	-	1075	-	
Reverse Transfer Capacitance	C _{rss}		-	52	-	
Switching characteristics	·					
Turn-on delay time	t _{d(on)}		-	22	-	ns
Turn-on rise time	t _r	V_{DD} =50V, RL=2.5 Ω	-	36	-	
Turn-off delay time	t _{d(off)}	V_{GS} =10V, R_G =6 Ω	-	49	-	
Turn-off fall time	t _f	1	-	31	-	
Total Gate Charge	Qg	\/D0_50\/ ID_00A	-	51	-	nC
Gate-Source Charge	Qgs	- VDS=50V, ID=20A, - VGS=10V	-	15	-	
Gate-Drain Charge	Qgd	7 VGS=10V	-	13	-	
Source-Drain Diode characteristics			•			
Diode Forward voltage ⁽³⁾	V _{DS}	V _{GS} =0V, I _S =20A	-	-	1.2	V
Diode Forward current ⁽⁴⁾	Is		-	-	120	Α
Reverse recovery time	overy time Trr Is=15A,V _{GS} =0V,dI _F /dt=100A/us			58		ns
Reverse recovery charge	Qrr	Is=15A,V _{GS} =0V,dI _F /dt=100A/us		90		nC

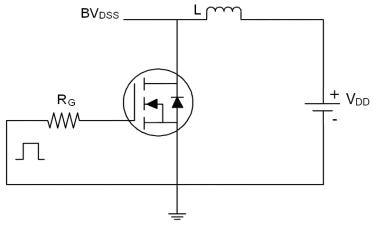
Notes:

- 1. Repetitive Rating: pulse width limited by maximum junction temperature
- 2. EAS Condition:TJ=25 $^{\circ}\text{C}$,VDD=50V,RG=25 $^{\Omega}$,L=0.5mH
- 3. Pulse Test: pulse width≤300µs, duty cycle≤2%
- 4. Surface Mounted on FR4 Board,t≤10 sec

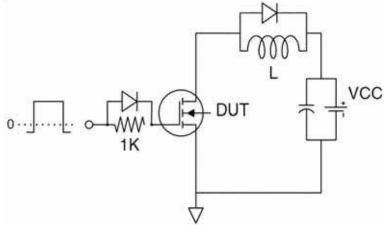


Test Circuit

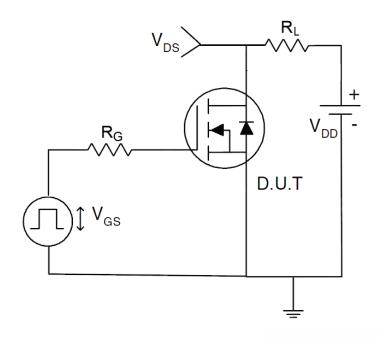
1) E_{AS} test Circuit



2) Gate charge test Circuit

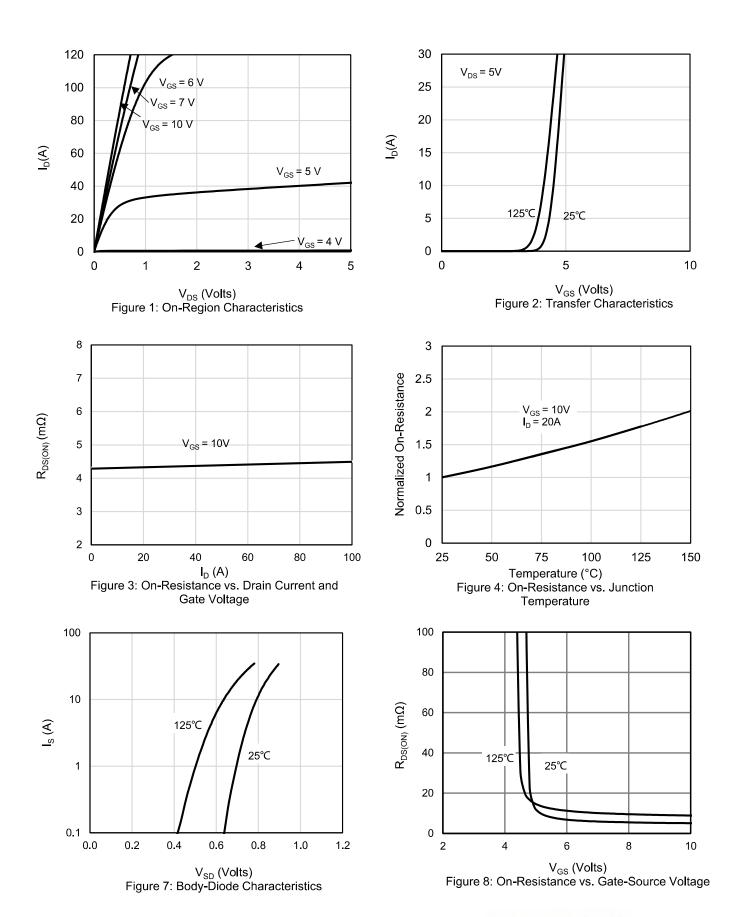


3) Switch Time Test Circuit

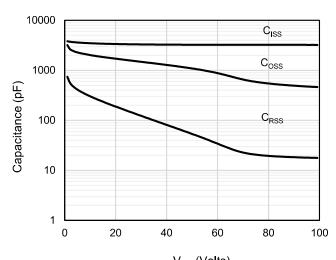




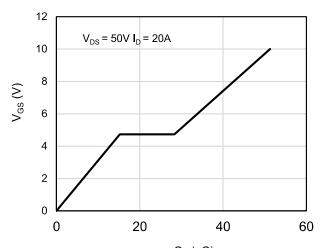
RATING AND CHARACTERISTICS CURVES (RM130N100T2)



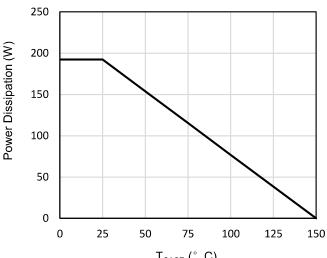
RATING AND CHARACTERISTICS CURVES (RM130N100T2)



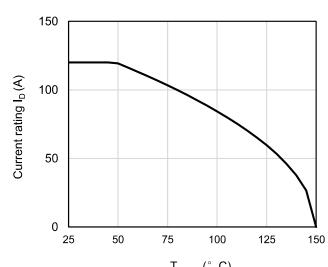
 V_{DS} (Volts) Figure 9: Capacitance Characteristics



 ${\rm Q_g\,(nC)}$ Figure 10: Gate-Charge Characteristics



 T_{CASE} (° C) Figure 11: Power De-rating



 T_{CASE} (° C) Figure 12: Current De-rating

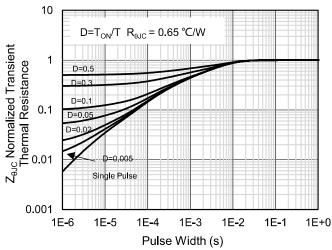


Figure 13: Normalized Maximum Transient
Thermal Impedance

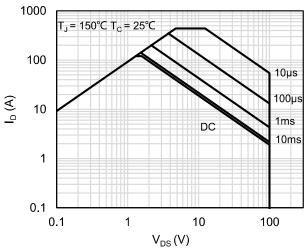
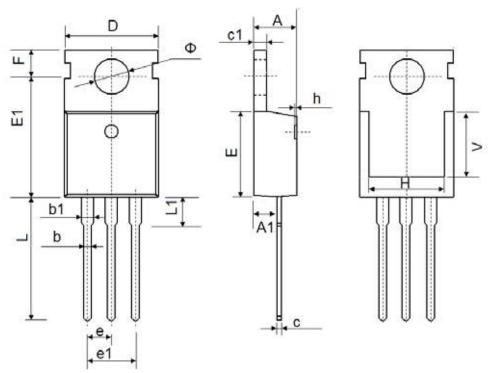


Figure 14: Maximum Forward Biased Safe
Operating Area



TO-220-3L Package Information



0	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
А	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
С	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.9500	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
е	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
Н	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 REF.		0.295 REF.	
Ф	3.400	3.800	0.134	0.150



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